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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Hogan et al.

Art Unit: 3742

Serial No.: 10/635,824

Examiner: Van, Quang T.

Filed: 6 August 2003

Docket No. TI-28996.1

For: METHOD FOR IMPROVING ASH RATE UNIFORMITY IN PHOTORESIST  
ASHING PROCESS EQUIPMENT

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## FACSIMILE COVER SHEET

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NAME OF INVENTOR(S): Hogan et al.	
TITLE OF INVENTION: Method for Improving Ash Rate Uniformity in Photoresist Ashing Process Equipment	
TI FILE NO.: TI-28996.1	DEPOSIT ACCT. NO.: 20-0668
FAXED: 10/22/2004	
DUE: 1/15/2004	
ATTY/SECY: CAB:ss	
RECEIPT DATE & SERIAL NO.: Application No.: 10/635,824 Filing Date: 6 August 2004	

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